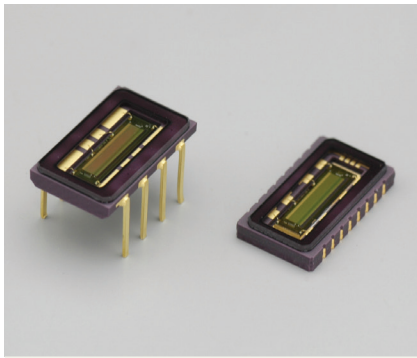


CMOS linear image sensors



S9227 series

**Video data rate: 5 MHz max.,
simultaneous charge integration**

The S9227 series is a small CMOS linear image sensor designed for image input applications. Signal charge is integrated on all pixels simultaneously and then read out of 5 MHz. Two package styles are provided: a DIP type and a surface mount type.

Features

- Pixel pitch: 12.5 μm
Pixel height: 250 μm
- 512 pixels
- 5 V single power supply operation
- Video data rate: 5 MHz max.
- Simultaneous charge integration
- Shutter function
- High sensitivity, low dark current, low noise
- Built-in timing generator allows operation with only start and clock pulse inputs.
- Spectral response range: 400 to 1000 nm
- Two package styles are provided:
DIP (dual inline package) type: S9227-03
Surface mount type: S9227-04

Applications

- Position detection
- Image reading

Structure

Parameter	Specification	Unit
Number of pixels	512	-
Pixel pitch	12.5	μm
Pixel height	250	μm
Photosensitive area length	6.4	mm
Package	Ceramic	-
Window material	Borosilicate glass (Tempax)	-

Absolute maximum ratings

Parameter	Symbol	Condition	Value	Unit
Supply voltage	Vdd	Ta=25 °C	-0.3 to +6	V
Clock pulse voltage	V(CLK)	Ta=25 °C	-0.3 to +6	V
Start pulse voltage	V(ST)	Ta=25 °C	-0.3 to +6	V
Operating temperature*1	Topr		-5 to +60	°C
Storage temperature*1	Tstg		-10 to +70	°C
Reflow soldering condition*2 *3	Tsol		Peak temperature 240 °C, 2 times (See P.7.)	-

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

*1: No condensation

*2: S9227-04

*3: JEDEC level 5

➤ Recommended terminal voltage (Ta=25 °C)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	Vdd	4.75	5	5.25	V
Clock pulse voltage	High level	Vdd - 0.25	Vdd	Vdd + 0.25	V
	Low level	-	0	-	V
Start pulse voltage	High level	Vdd - 0.25	Vdd	Vdd + 0.25	V
	Low level	-	0	-	V

➤ Electrical characteristics [Ta=25 °C, Vdd=5 V, V(CLK)=V(ST)=5 V]

Parameter	Symbol	Min.	Typ.	Max.	Unit
Clock pulse frequency	f(CLK)	50 k	-	5 M	Hz
Video data rate	VR	-	f(CLK)	-	Hz
Current consumption*4	I	20	26	32	mA
Conversion efficiency	CE	-	1.6	-	μV/e ⁻
Output impedance	Zo	-	50	200	Ω

*4: f(CLK)=5 MHz

➤ Electrical and optical characteristics [Ta=25 °C, Vdd=5 V, V(CLK)=V(ST)=5 V, f(CLK)=5 MHz]

Parameter	Symbol	Min.	Typ.	Max.	Unit
Spectral response range	λ	400 to 1000			nm
Peak sensitivity wavelength	λp	-	650	-	nm
Dark current	ID	-	10	100	fA
Saturation charge	Qsat	400	430	-	fC
Dark output voltage*5	Vd	-	1	10	mV
Saturation output voltage*6	Vsat	4	4.3	-	V
Readout noise*7	Nr	-	0.45	2	mV rms
Output offset voltage	Vo	-	0.6	0.9	V
Photoresponse nonuniformity*8 *9	PRNU	-	-	±5	%

*5: Integration time=10 ms

*6: Voltage difference with respect to Vo

*7: Dark state

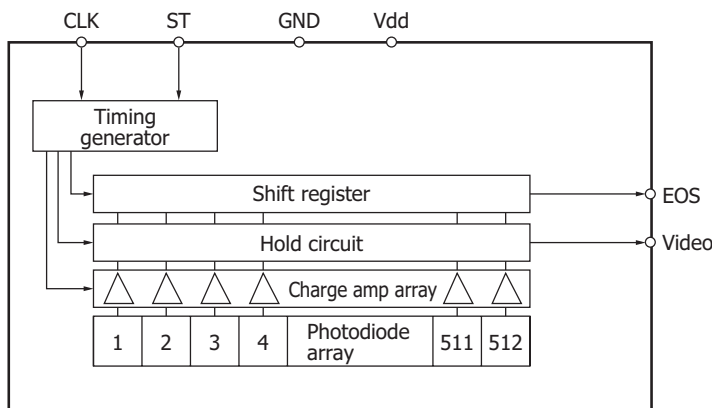
*8: Photoresponse nonuniformity (PRNU) is the output nonuniformity that occurs when the entire photosensitive area is uniformly illuminated by light which is 50% of the saturation exposure level. PRNU is measured using 510 pixels excluding the pixels at both ends, and is defined as follows:

$$PRNU = \frac{\Delta X}{X} \times 100 (\%)$$

X: average output of all pixels, ΔX: difference between X and maximum or minimum output

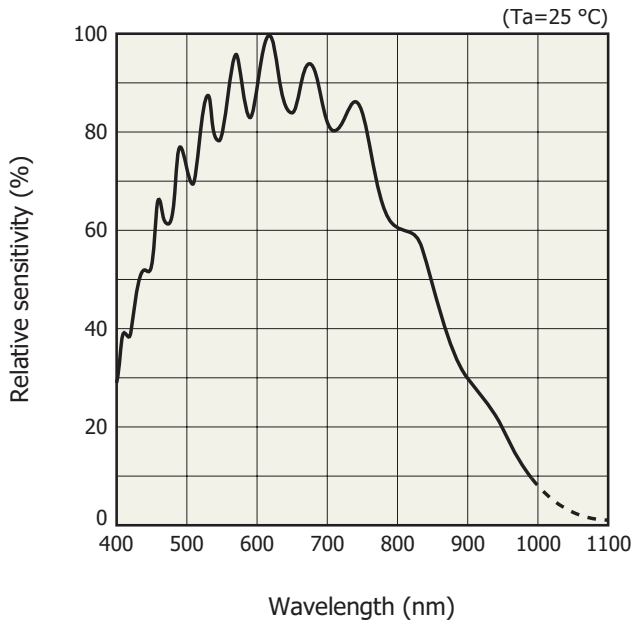
*9: Measured with a tungsten lamp of 2856 K

➤ Block diagram



KMPDC0167EB

Spectral response (typical example)



KMPD80230EC

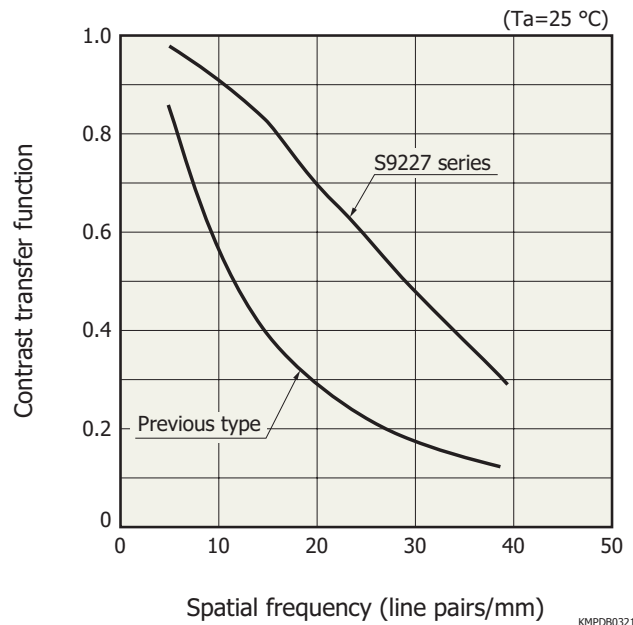
Resolution

CTF: contrast transfer function

$$CTF = \frac{V_{WO} - V_{BO}}{V_W - V_B}$$

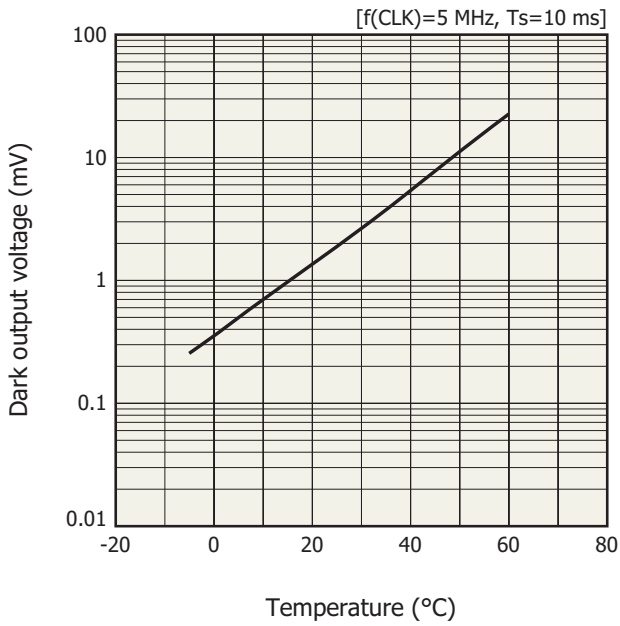
- V_{WO} : output white level
- V_{BO} : output black level
- V_W : output white level (when input pattern pulse width is wide)
- V_B : output black level (when input pattern pulse width is wide)

Contrast transfer function vs. spatial frequency (typical example)



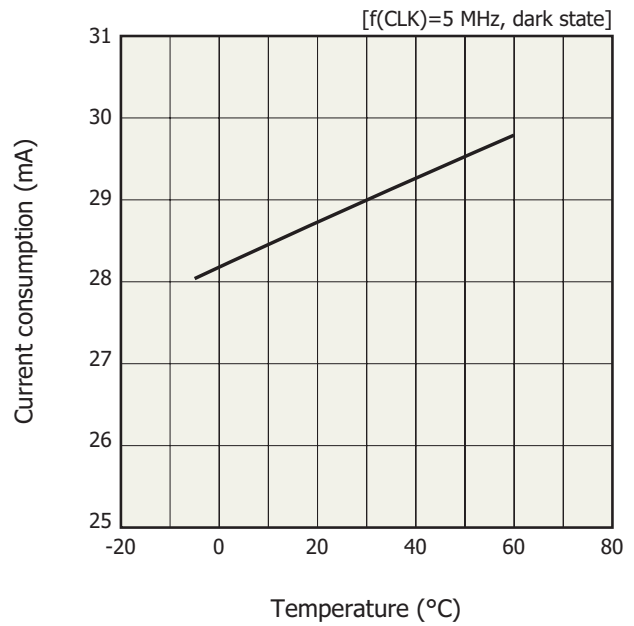
KMPD80321EB

Dark output voltage vs. temperature (typical example)



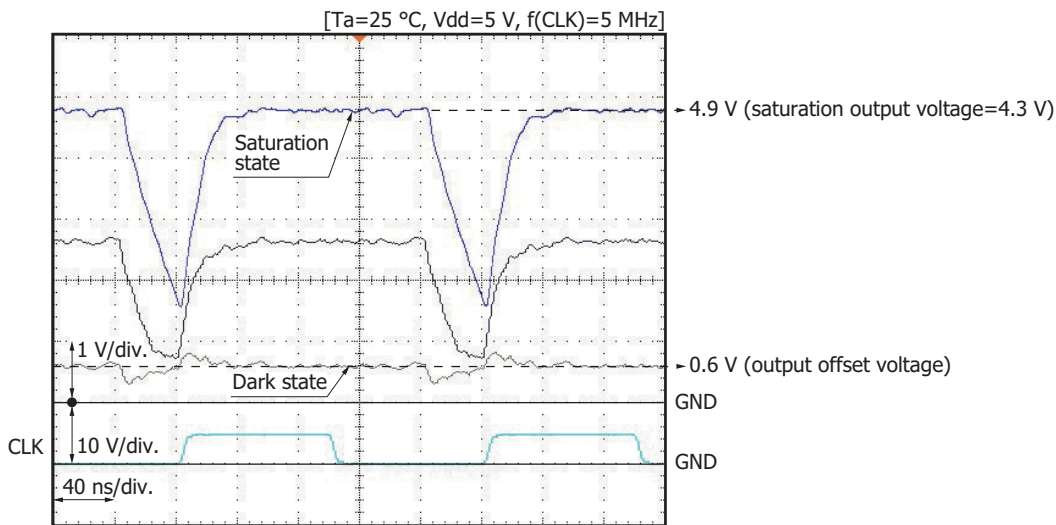
KMPDB0322EC

Current consumption vs. temperature (typical example)

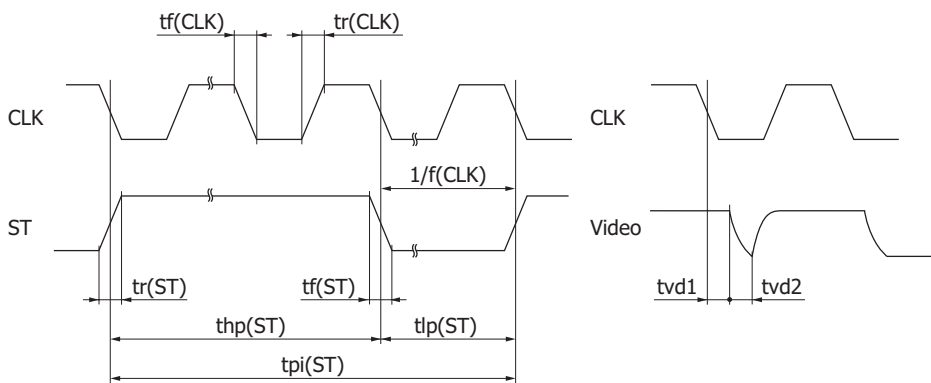
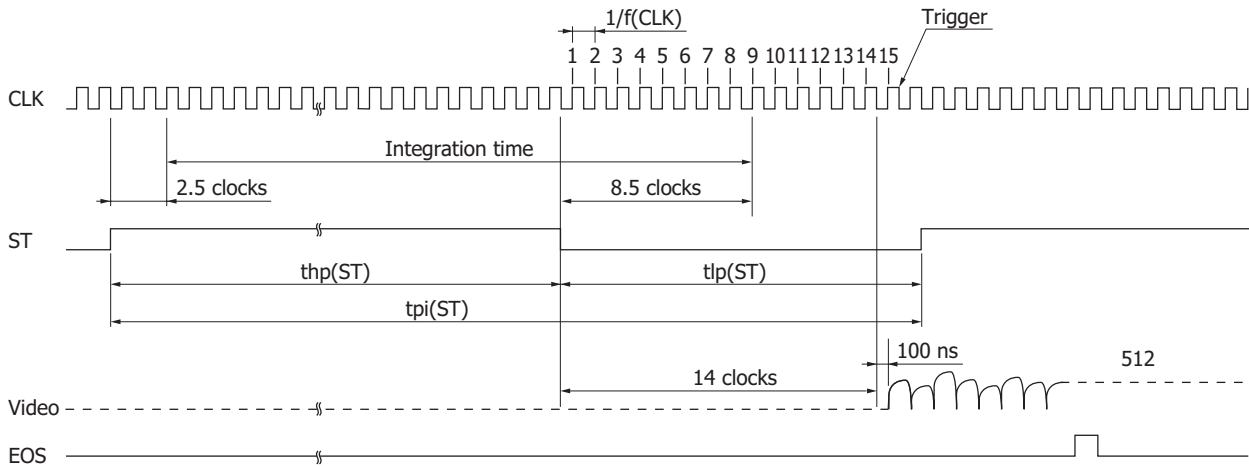


KMPDB0322EC

Output waveform of one element



Timing chart



KMPDC0166EF

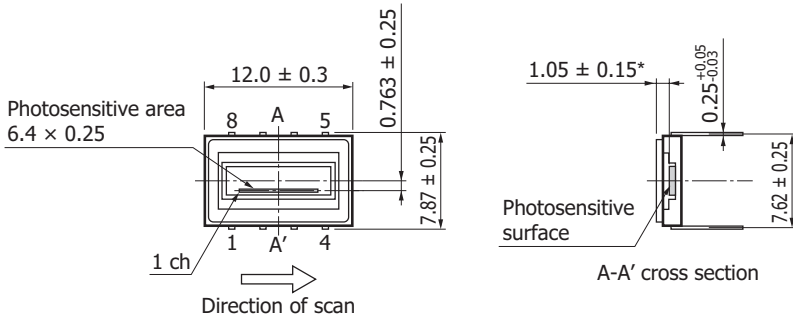
Parameter	Symbol	Min.	Typ.	Max.	Unit
Start pulse cycle	tpi(ST)	530/f(CLK)	-	1100 m	s
Start pulse high period	thp(ST)	8/f(CLK)	-	1000 m	s
Start pulse low period	tlp(ST)	15/f(CLK)	-	100 m	s
Start pulse rise and fall times	tr(ST), tf(ST)	0	20	30	ns
Clock pulse duty ratio	-	45	50	55	%
Clock pulse rise and fall times	tr(CLK), tf(CLK)	0	20	30	ns
Video delay time 1	tvd1	32	40	48	ns
Video delay time 2	tvd2	40	50	60	ns

Note: The internal timing circuit starts operating at the rise of CLK pulse immediately after ST pulse sets to low.
 The integration time equals the high period of ST pulse plus 6 CLK cycles.
 The output from 1st channel appears 14 clocks plus 100 ns after the falling edge of ST pulse.
 The EOS pulse is output 39 ns after the falling edge of CLK pulse.
 The output voltage after reading the last pixel (512 ch) is indefinite.
 The integration time can be changed by changing the high-to-low ratio of ST pulses.

Start pulse setting example (for setting the start pulse cycle to a minimum and the integration time to a maximum)
 Start pulse high period=515/f(CLK), Start pulse low period=15/f(CLK)

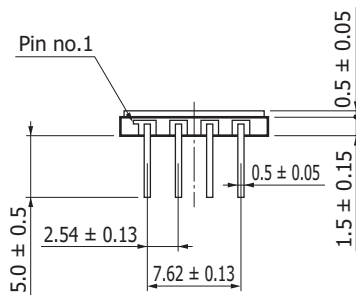
Dimensional outlines (unit: mm)

S9227-03



* Distance from upper surface of window to photosensitive surface

KMPDA0173EF

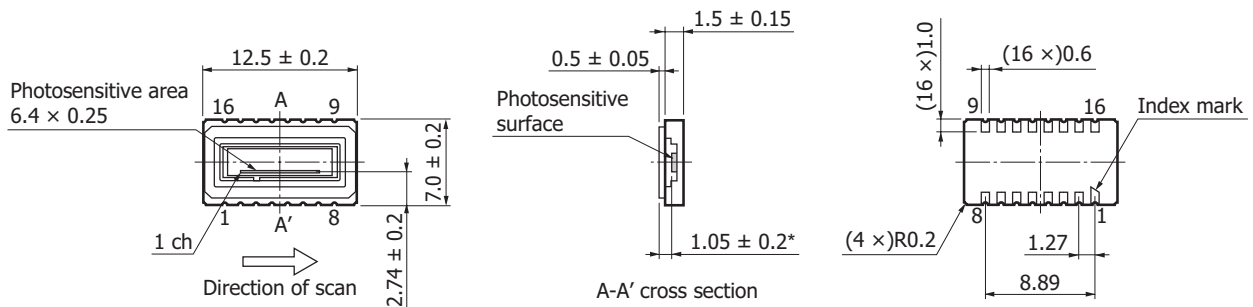


Pin no.	Symbol	I/O	Pin name
1	GND		Ground
2	NC		No connection
3	NC		No connection
4	Vdd	I	Supply voltage
5	Video	O	Video signal* ¹⁰
6	EOS	O	End of scan
7	ST	I	Start pulse
8	CLK	I	Clock pulse

*10: Connect a buffer amplifier for impedance conversion to the video output terminal so as to minimize the current flow. As the buffer amplifier, use a high input impedance operational amplifier with JFET or CMOS input.

Note: Leave the "NC" terminals open and do not connect them to GND.

S9227-04



* Distance from upper surface of window to photosensitive surface

KMPDA0281EC

Pin no.	Symbol	I/O	Pin name	Pin no.	Symbol	I/O	Pin name
1	NC		No connection	9	NC		No connection
2	NC		No connection	10	NC		No connection
3	GND		Ground	11	Video	O	Video signal* ¹⁰
4	NC		No connection	12	EOS	O	End of scan
5	NC		No connection	13	ST	I	Start pulse
6	Vdd	I	Supply voltage	14	CLK	I	Clock pulse
7	NC		No connection	15	NC		No connection
8	NC		No connection	16	NC		No connection

*10: Connect a buffer amplifier for impedance conversion to the video output terminal so as to minimize the current flow. As the buffer amplifier, use a high input impedance operational amplifier with JFET or CMOS input.

Note: Leave the "NC" terminals open and do not connect them to GND.

Precautions

(1) Electrostatic countermeasures

This device has a built-in protection circuit against static electrical charges. However, to prevent destroying the device with electrostatic charges, take countermeasures such as grounding yourself, the workbench and tools to prevent static discharges. Also protect this device from surge voltages which might be caused by peripheral equipment.

(2) Light input window

If the incident window is contaminated or scratched, the output uniformity will deteriorate considerably, so care should be taken in handling the window. Avoid touching it with bare hands.

The window surface should be cleaned before using the device. If dry cloth or dry cotton swab is used to rub the window surface, static electricity may be generated, and therefore this practice should be avoided. Use soft cloth, cotton swab or soft paper moistened with ethyl alcohol to wipe off dirt and foreign matter on the window surface.

(3) Soldering

To prevent damaging the device during soldering, take precautions to prevent excessive soldering temperatures and times. Soldering should be performed within 5 seconds at a soldering temperature below 260 °C.

(4) Reflow soldering (S9227-04)

Soldering conditions may differ depending on the board size, reflow furnace, etc. Check the conditions before soldering. A sudden temperature rise and cooling may be the cause of trouble, so make sure that the temperature change is within 4 °C per second.

The bonding portion between the ceramic base and the glass may discolor after reflow soldering, but this has no adverse effects on the hermetic sealing of the product.

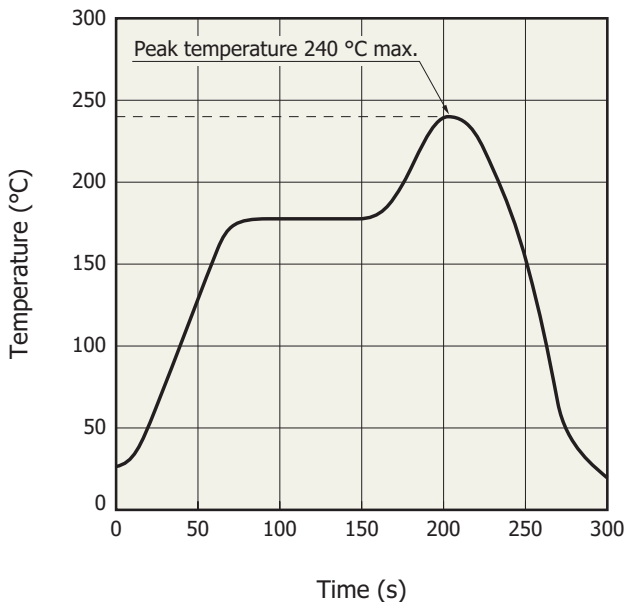
(5) Operating and storage environments

Handle the device within the temperature range specified in the absolute maximum ratings. Operating or storing the device at an excessively high temperature and humidity may cause variations in performance characteristics and must be avoided.

(6) UV exposure

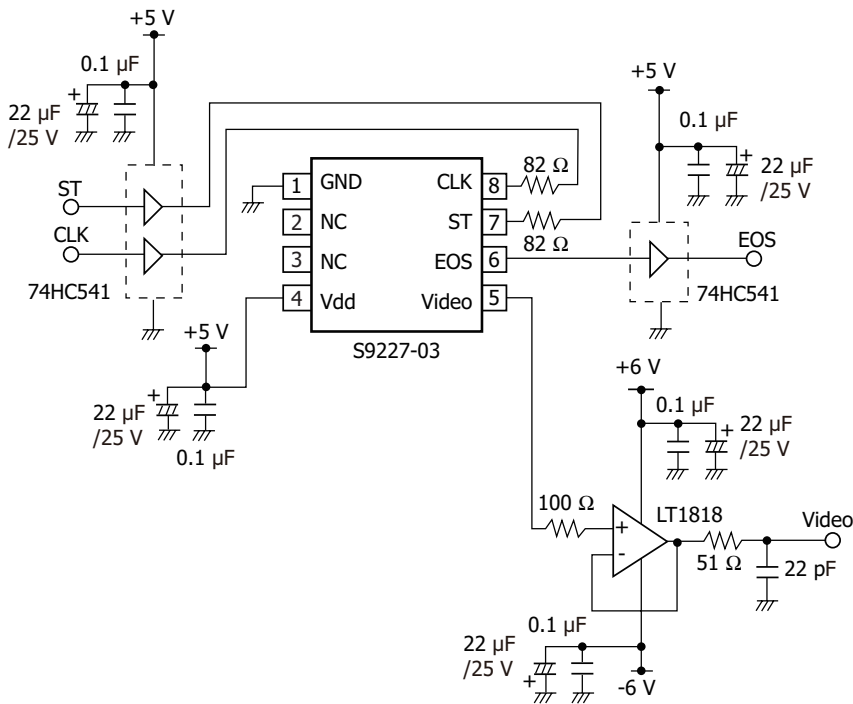
This product is not designed to prevent deterioration of characteristics caused by UV exposure, so do not expose it to UV light.

Recommended temperature profile of reflow soldering (S9227-04)



KAPDB0169EA

Application circuit example (S9227-03)*11



KMPDC0415EA

*11: The S9227-04 has a different pin connections, but uses the same circuit.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

Precautions

- Disclaimer
- Image sensors/Precautions
- Surface mount type products/Precautions

Information described in this material is current as of August, 2017.

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